# 2SCR583D3 FRA

NPN 7A 50V Power Transistor

**Datasheet** 

## **AEC-Q101 Qualified**

Parameter	Value
V <sub>CEO</sub>	50V
IC	7A

# 

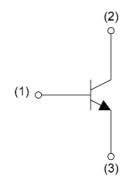
## Features

- 1) Suitable for Power Driver.
- 2) Complementary PNP Types: 2SAR583D3 FRA.
- 3) Low V<sub>CE(sat)</sub>

 $V_{CE(sat)}$ =350mV(Max.). ( $I_C/I_B$ =3A/150mA)

# ●Inner circuit

Outline



- (1) Base
- (2) Collector
- (3) Emitter

## Application

LOW FREQUENCY AMPLIFIER

## Packaging specifications

Part No.	Package	Taping code	Reel size (mm)	Tape width (mm)	Quantity (pcs)	Marking
2SCR583D3 FRA	TO-252 (DPAK)	TL	330	16	2500	2SCR583D3

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	$V_{CBO}$	50	V
Collector-emitter voltage	V <sub>CEO</sub>	50	V
Emitter-base voltage	$V_{EBO}$	6	V
Collector current	I <sub>C</sub>	7	Α
Collector current	I <sub>CP</sub> *1	14	Α
Power dissipation	P <sub>D</sub> *2	10	W
Junction temperature	T <sub>j</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
raiailletei	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = 100μA	50	-	-	V	
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	50	1	-	V	
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = 100μA	6	-	-	V	
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 50V	-	-	1	μA	
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 4V	-	-	1	μA	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub> *3	I <sub>C</sub> = 3A, I <sub>B</sub> = 150mA	-	160	350	mV	
DC current gain	h <sub>FE</sub> *3	V <sub>CE</sub> = 3V, I <sub>C</sub> = 1A	180	-	450	-	
Transition frequency	f <sub>T</sub> *3	$V_{CE} = 10V, I_{E} = -1A,$ f = 100MHz	-	280	-	MHz	
Output capacitance	C <sub>ob</sub>	$V_{CB} = 10V$ , $I_E = 0A$ , $f = 1MHz$	-	65	-	pF	
Turn-On time	t <sub>on</sub>	I <sub>C</sub> = 3.5A, I <sub>B1</sub> = 350mA,	ı	50	1	ns	
Storage time	$\mathbf{t}_{stg}$	$I_{B2} = -350 \text{mA},$ $V_{CC} \approx 10 \text{V},$	ı	500	-	ns	
Fall time	t <sub>f</sub>	$R_L = 2.87\Omega$ See test circuit	-	150	-	ns	

<sup>\*1</sup> Pw=10ms Single Pulse

<sup>\*2</sup> Tc=25℃

<sup>\*3</sup> Pulsed

# ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.1 Grounded Emitter Propagation Characteristics

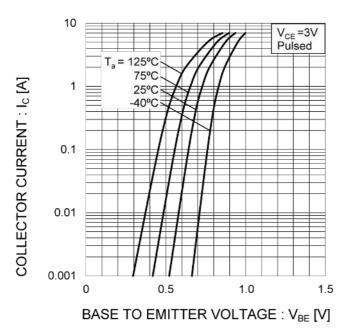
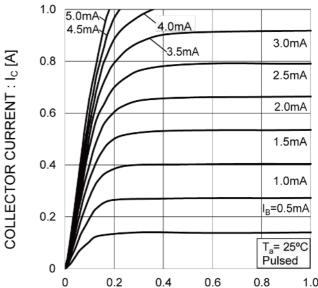


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: VCE [V]

Fig.3 DC Current Gain vs. Collector Current(I)

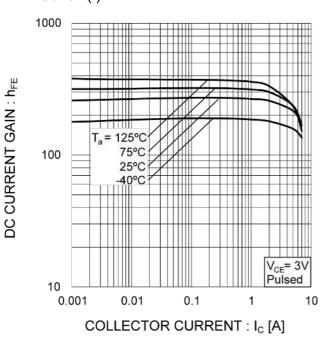
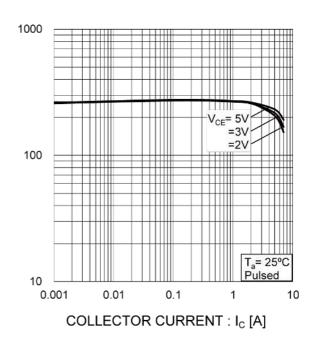


Fig.4 DC Current Gain vs. Collector Current(II)



DC CURRENT GAIN: he

# ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current(I)

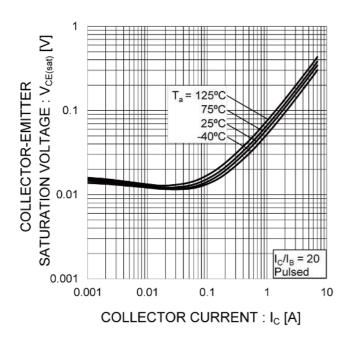


Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current(II)

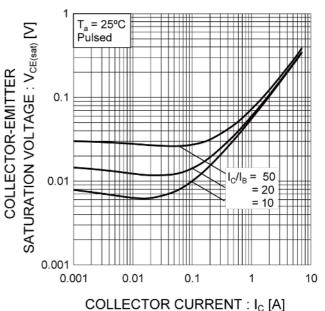


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

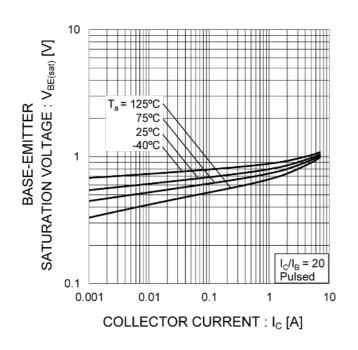
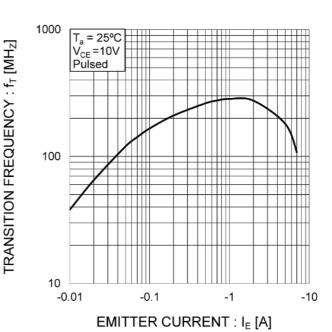


Fig.8 Gain Bandwidth Product vs. Emitter Current



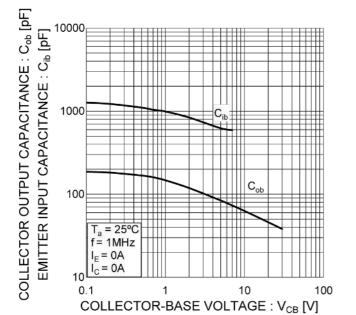
# ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.9 Emitter input capacitance vs.

**Emitter-Base Voltage** 

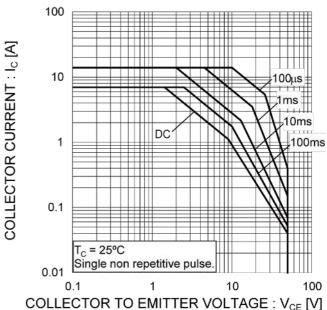
Collector output capacitance vs.

Collector-Base Voltage

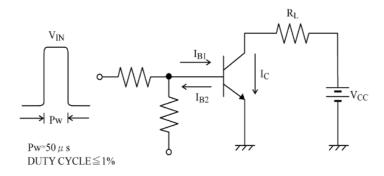


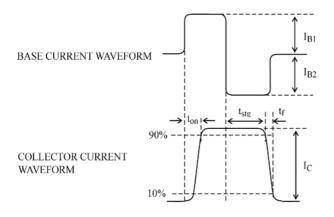
EMITTER-BASE VOLTAGE: VEB [V]

Fig.10 Safe Operating Area



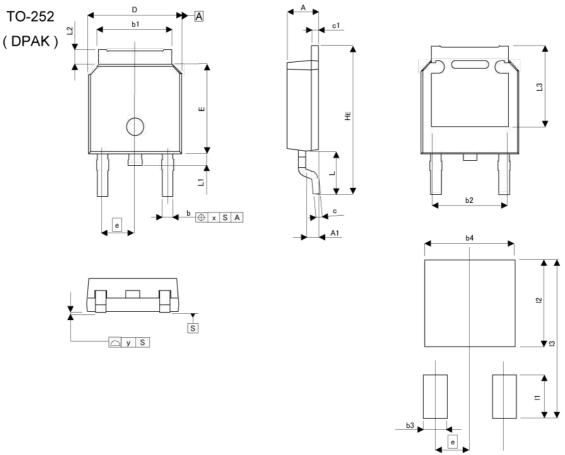
## SWITCHING TIME TEST CIRCUIT







## Dimensions



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM -	MILIME	ETERS	INC	HES
DIIVI	MIN	MAX	MIN	MAX
Α	2.10	2.30	0.083	0.091
A1	0.70	1.10	0.028	0.043
b	0.65	0.85	0.026	0.033
b1	5.10	5.40	0.201	0.213
b2	5.	10	0.2	201
С	0.40	0.60	0.016	0.024
c1	0.40	0.60	0.016	0.024
D	6.40	6.80	0.252	0.268
е	2.	30	0.0	91
E	6.00	6.40	0.236	0.252
HE	9.50	10.50	0.374	0.413
L	2.	90	0.1	14
L1	0.70	0.90	0.028	0.035
L2	0.70	1.30	0.028	0.051
L3	5.30		0.2	209
Х	-	0.10	10 <b>-</b> 0	0.004
у	-	0.10		0.004

DIM	MILIME	ETERS	INC	HES
	MIN	MAX	MIN	MAX
b3	25	1.10	7/27	0.043
b4	+	5.40	3,52	0.213
11	20	2.90	Nay	0.114
12	*	5.50	0.50	0.217
13	<u>~</u>	10.50	1524	0.413

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Applications

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JAPAN	USA	EU	CHINA			
CLASSIII	CLASSⅢ	CLASSIIb	CL ACCTI			
CLASSIV	CLASSIII	CLASSⅢ	CLASSⅢ			

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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  - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

## **Precaution for Mounting / Circuit board design**

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

## **Precautions Regarding Application Examples and External Circuits**

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

## **Precaution for Storage / Transportation**

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

## **Precaution for Product Label**

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

#### **Precaution for Disposition**

When disposing Products please dispose them properly using an authorized industry waste company.

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